

TI *Live*! 相約在 AMPA

探索汽車電氣化的重大趨勢

Designing automotive systems can be challenging





Why TI for automotive



Our technology, design resources, manufacturing and purchasing process empower you to create innovative automotive solutions and bring them to market faster.

Broad portfolio designed for auto

7,000+ auto-qualified analog and embedded processing products

Source a wide range of automotive products from a single supplier

The right parts for your design needs

Continuously innovating

40+ years designing products for automotive

Consistently introduced 500+ new automotive ICs annually since 2014

Driving innovation at every step of the product cycle

System expertise

Our engineers work with you to understand your unique vision, meet your deadlines and get you to production

Tools, software and local support help accelerate time to market

Support for 150 automotive applications and 350+ fully tested reference designs on TI.com



Delivering automotive quality and global supply



Automotive quality

Holistic approach to quality, from process technology and design through manufacturing, packaging, test and delivery

Easy access to industry documentation helps you effectively meet rigorous quality and safety requirements

We deliver quality products, manufacturing and support you can rely on. Industryleading global supply chain Expanding manufacturing to increase supply and enhance business continuity

15 manufacturing sites worldwide, multiple new factories coming on line 2022

Increased manufacturing capacity by 50% from 2016 to 2020

Investing in 40nm - 130nm process nodes

Continuously redesigning popular, durable parts to new technology processes, for higher quality and greater device longevity



Driving automotive innovation forward



Hybrid and electric vehicles

Highly accurate battery monitoring for longer distances between charges and safer, more affordable vehicles

Advanced driver assistance systems

Portfolio of automotive-qualified ICs, including highly-accurate radar SoCs, powerful processors and reliable power management products

Infotainment and cluster

Immersive systems that keep drivers more informed and less distracted

Body electronics and lighting

Innovative analog and embedded processors to optimize comfort and convenience





Our continuous innovation, technology and expertise help you maximize driving range, make EVs more affordable, enable faster charging and safer operation.





HEV/EV | Trends and Technology



HEV/EV Trends



30% of new cars will

be HEV/EV in 2025

800V batteries for higher efficiency and faster charging



Wireless battery management and EIS





 \rightarrow

Powertrain Integration



Sustainable battery chemistries like LFP

Wide bandgap switches

like GaN & SiC



TI Technology |

Maximizing driving range with industry's leading performance and reliable solution



Double the speed of your motor and increase efficiency with our <u>Real-Time Control MCUs</u> with less than 2µs current loop speed. ASIL-D, Security, and AUTOSAR + Control for highest system integration.

Maximize drive range by enhancing state-of-charge accuracy with high-precision, 1mV accurate <u>Battery Monitors</u> with voltage + current synchronization & Electrical Impedance Spectroscopy (EIS)

Batter y Monitor s



Our wireless protocol enables secure, high-performance <u>Connectivity Products</u> with high data throughput up to 1.2 Mbps and latency less than 2ms per node.

Drive high-power SiC MOSFETs and IGBTs with our 30A, adjustable strength <u>Isolated Gate Drivers</u>. Provide 1.5W powerat <u>+</u>1.3% accuracy with <u>Integrated Transformer Technology Bias Supplies</u>.

Isolated Gate Drivers & Bias Supplies



TEXAS

Switch up to 1MHz and shrink magnetics by over 60% with Tl's Automotive GaN. Integrated drivers and protections offer switching speeds as fast as 150V/ns.



Hybrid, electric & powertrain systems





8

Emerging trends in powertrain integration

- Powertrain integration towards Domain Controller integrates
 Traction Inverters together with OBC/DCDC/PDU/BMU
- E-Axle / Dual Inverter vehicles (AWD) and/or architecture from 3-phase to 6-phase (better torque control, higher power, higher motor efficiency)
- Increasing power level and FuSa requirement (100kW to 500kW, ASILC to ASILD)
- Shifting towards 800V Technology with increased switching dv/dt, more stringent on system reliability and efficiency requirement
- Adjustable gate drive strength needed to reduce overshoot, optimize efficiency and EMI
- Inductive position sensing technology as alternative to resolver for cost reduction (xMR, eddy current)





Inverter + Motor + Reducer

Inverter + OBC + HV DCDC



Inverter + HV DCDC







Advanced driver assistance systems (ADAS)

Vehicle safety systems are constantly evolving, leading automakers to envision a world where vehicle collisions are a thing of the past.



ADAS vehicle architecture continues to evolve

Distributed systems

- State of the art today
- Processing on the edge processor close to sensor
- Easy to manage
- Power and size constraints





Hybrid centralized system

- High-speed RAW data transmission to node processor
- Aggregate common sensor nodes into central fusion ECU (each processor node transmits object data to fusion ECU)
- Easy to manage
- Easily scalable
- Sensing units can be very small
- Power and size can be relaxed

Fully centralized processing



- Massive compute
- Challenges:
 - Scaling across the fleet
 - Managing multi-vendor collaboration on one chip
 - Multiple vendor systems on one chip raises safety & responsibility issues



Broad portfolio designed for ADAS





Enhancing ADAS with innovative technology

SENSE

mmWave radar sensors

TI mmWave radar solutions enable safer and easier driving experiences by sensing and reacting to exterior and interior environments. Reduce system size and cost while optimizing high-speed data transfer in camera designs for advanced driver assistance systems.

COMMUNICATE

SERDES FPDLink

PROCESS

Arm[®] based processors

Enhance automated driving with AEC Q100-qualified Arm-based processors.

PMIC solutions for automotive camera and radar applications, most with robust fault protection and monitoring.





Infotainment and cluster systems

Create an in-vehicle experience that connects the car and presents information and entertainment with sound and display quality that rivals consumer electronics.



The next-generation digital cockpit

Enable infotainment, display and vehicle-toeverything (V2X) systems that minimize distractions, and help drivers stay informed and connected to the world.

Cluster

Telematics

Display

Integrated cockpit

Head unit

Media interface

Premium audio





Vehicle-to-everything

(V2X), Safe and reliable communication between vehicles, infrastructure and the cloud.



Body electronic and lighting systems

Accelerating the evolution of passenger comfort and convenience. Advance your body electronics and lighting system design with our smart, scalable and efficient solutions.



Personalize the in-vehicle experience

Leverage our products and system resources to create body electronics and lighting systems that are more advanced, efficient and flexible.

Automotive lighting Body control module & gateway Body motors Heating & cooling Car access and security systems Power seats Steering column Automotive HMI Mirrors Body sensors Auxiliary power





Driving body electronics, lighting, passenger comfort and convenience forward.



Driving automotive forward

Paving the way for safer, more reliable EVs with cutting-

edge automotive

systems

- We address the most complex design challenges through our decades of automotive expertise.
- We enable you to easily and cost-effectively integrate high-performance driver assistance capabilities into any vehicle.
- We anticipate the ever-evolving regulatory and technological needs of tomorrow.



THANK YOU

Visit <u>www.ti.com</u> for more information and useful resources.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2022, Texas Instruments Incorporated